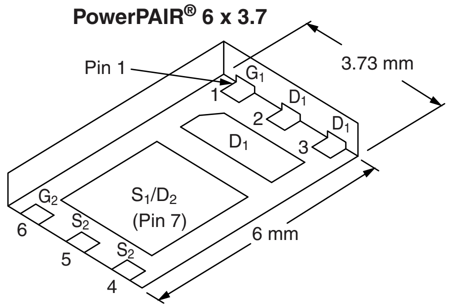
N-Channel 20 V (D-S) MOSFETs

PRODUCT SUMMARY

	V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)	Q_g (Typ.)
Channel-1	20	0.0068 at V_{GS} = 10 V	16[a]	6.9 nC
		0.0090 at V_{GS} = 4.5 V	16[a]	
Channel-2	20	0.0033 at V_{GS} = 10 V	35[a]	18.2 nC
		0.0043 at V_{GS} = 4.5 V	35[a]	

PowerPAIR® 6 x 3.7



Ordering Information:
SiZ710DT-T1-GE3 (Lead (Pb)-free and Halogen-free)

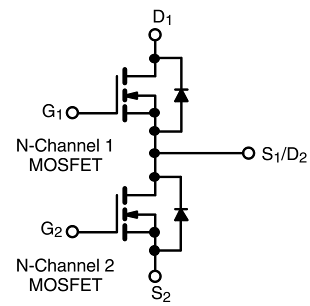
FEATURES

- **Halogen-free According to IEC 61249-2-21 Definition**
- TrenchFET® Power MOSFETs
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Notebook System Power
- POL
- Synchronous Buck Converter



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

Parameter		Symbol	Channel-1	Channel-2	Unit
Drain-Source Voltage		V_{DS}	20		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Drain Current (T_J = 150 °C)	T_C = 25 °C	I_D	16[a]	35[a]	A
	T_C = 70 °C		16[a]	35[a]	
	T_A = 25 °C		16[a, b, c]	30[b, c]	
	T_A = 70 °C		15[b, c]	24[b, c]	
Pulsed Drain Current		I_{DM}	70	100	
Continuous Source Drain Diode Current	T_C = 25 °C	I_S	16[a]	35[a]	
	T_A = 25 °C		3.2[b, c]	3.8[b, c]	
Single Pulse Avalanche Current	L = 0.1 mH	I_{AS}	20	30	
Single Pulse Avalanche Energy		E_{AS}	20	45	mJ
Maximum Power Dissipation	T_C = 25 °C	P_D	27	48	W
	T_C = 70 °C		17	31	
	T_A = 25 °C		3.9[b, c]	4.6[b, c]	
	T_A = 70 °C		2.5[b, c]	3[b, c]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature)[d, e]			260		

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Channel-1		Channel-2		Unit
			Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient[b, f]	t ≤ 10 s	R_{thJA}	24	32	20	27	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	3.5	4.6	2	2.6	

Notes:
a. Package limited.
b. Surface mounted on 1" x 1" FR4 board.
c. t = 10 s.
d. See solder profile (www.vishay.com/doc?73257). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
f. Maximum under steady state conditions is 67 °C/W for channel-1 and 65 °C/W for channel-2.

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)

Parameter	Symbol	Test Conditions		Min.	Typ.	Max.	Unit
Static							
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	Ch-1	20			V
		V_{GS} = 0 V, I_D = 250 µA	Ch-2	20			
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = 250 µA	Ch-1		19		mV/°C
		I_D = 250 µA	Ch-2		20		
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 µA	Ch-1		- 4.8		
		I_D = 250 µA	Ch-2		- 5.3		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, I_D = 250 µA	Ch-1	1		2.2	V
		$V_{DS} = V_{GS}$, I_D = 250 µA	Ch-2	1		2.2	
Gate Source Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	Ch-1			± 100	nA
			Ch-2			± 100	
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 20 V, V_{GS} = 0 V	Ch-1			1	µA
		V_{DS} = 20 V, V_{GS} = 0 V	Ch-2			1	
		V_{DS} = 20 V, V_{GS} = 0 V, T_J = 55 °C	Ch-1			5	
		V_{DS} = 20 V, V_{GS} = 0 V, T_J = 55 °C	Ch-2			5	
On-State Drain Current[b]	$I_{D(on)}$	$V_{DS} \geq 5$ V, V_{GS} = 10 V	Ch-1	15			A
		$V_{DS} \geq 5$ V, V_{GS} = 10 V	Ch-2	20			
Drain-Source On-State Resistance[b]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 19 A	Ch-1		0.0055	0.0068	Ω
		V_{GS} = 10 V, I_D = 20 A	Ch-2		0.0027	0.0033	
		V_{GS} = 4.5 V, I_D = 16.5 A	Ch-1		0.0072	0.0090	
		V_{GS} = 4.5 V, I_D = 20 A	Ch-2		0.0034	0.0043	
Forward Transconductance[b]	g_{fs}	V_{DS} = 10 V, I_D = 19 A	Ch-1		45		S
		V_{DS} = 10 V, I_D = 20 A	Ch-2		85		
Dynamic[a]							
Input Capacitance	C_{iss}	Channel-1 V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz Channel-2 V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	Ch-1		820		pF
			Ch-2		2310		
Output Capacitance	C_{oss}		Ch-1		290		
			Ch-2		730		
Reverse Transfer Capacitance	C_{rss}		Ch-1		115		
			Ch-2		305		
Total Gate Charge	Q_g	V_{DS} = 10 V, V_{GS} = 10 V, I_D = 19 A	Ch-1		11.5	18	nC
		V_{DS} = 10 V, V_{GS} = 10 V, I_D = 20 A	Ch-2		38	60	
		Channel-1 V_{DS} = 10 V, V_{GS} = 4.5 V, I_D = 16.8 A Channel-2 V_{DS} = 10 V, V_{GS} = 4.5 V, I_D = 20 A	Ch-1		6.9	11	
			Ch-2		18.2	28	
Gate-Source Charge	Q_{gs}		Ch-1		2.4		
			Ch-2		6.6		
Gate-Drain Charge	Q_{gd}		Ch-1		1.7		
			Ch-2		4.8		
Gate Resistance	R_g	f = 1 MHz	Ch-1	0.3	1.3	2.6	Ω
			Ch-2	0.2	0.8	1.6	

Notes:
a. Guaranteed by design, not subject to production testing.
b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions		Min.	Typ.	Max.	Unit
Dynamic[a]							
Turn-On Delay Time	$t_{d(on)}$	Channel-1 V_{DD} = 10 V, R_L = 1 Ω $I_D \cong$ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω Channel-2 V_{DD} = 10 V, R_L = 1 Ω $I_D \cong$ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω	Ch-1		15	30	ns
			Ch-2		25	50	
Rise Time	t_r		Ch-1		15	30	
			Ch-2		15	30	
Turn-Off Delay Time	$t_{d(off)}$		Ch-1		20	40	
			Ch-2		30	60	
Fall Time	t_f		Ch-1		12	25	
			Ch-2		12	25	
Turn-On Delay Time	$t_{d(on)}$	Channel-1 V_{DD} = 10 V, R_L = 1 Ω $I_D \cong$ 10 A, V_{GEN} = 10 V, R_g = 1 Ω Channel-2 V_{DD} = 10 V, R_L = 1 Ω $I_D \cong$ 10 A, V_{GEN} = 10 V, R_g = 1 Ω	Ch-1		10	20	
			Ch-2		15	30	
Rise Time	t_r		Ch-1		12	25	
			Ch-2		8	15	
Turn-Off Delay Time	$t_{d(off)}$		Ch-1		20	40	
			Ch-2		30	60	
Fall Time	t_f		Ch-1		10	20	
			Ch-2		10	20	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C	Ch-1			16	A
			Ch-2			35	
Pulse Diode Forward Current[a]	I_{SM}		Ch-1			70	
			Ch-2			100	
Body Diode Voltage	V_{SD}	I_S = 10 A, V_{GS} = 0 V	Ch-1		0.8	1.2	V
		I_S = 10 A, V_{GS} = 0 V	Ch-2		0.78	1.2	
Body Diode Reverse Recovery Time	t_{rr}	Channel-1 I_F = 10 A, dI/dt = 100 A/µs, T_J = 25 °C Channel-2 I_F = 10 A, dI/dt = 100 A/µs, T_J = 25 °C	Ch-1		15	30	ns
			Ch-2		25	50	
Body Diode Reverse Recovery Charge	Q_{rr}		Ch-1		5.5	11	nC
			Ch-2		17	35	
Reverse Recovery Fall Time	t_a		Ch-1		6		ns
			Ch-2		14		
Reverse Recovery Rise Time	t_b		Ch-1		9		
			Ch-2		11		

Notes:
a. Guaranteed by design, not subject to production testing.
b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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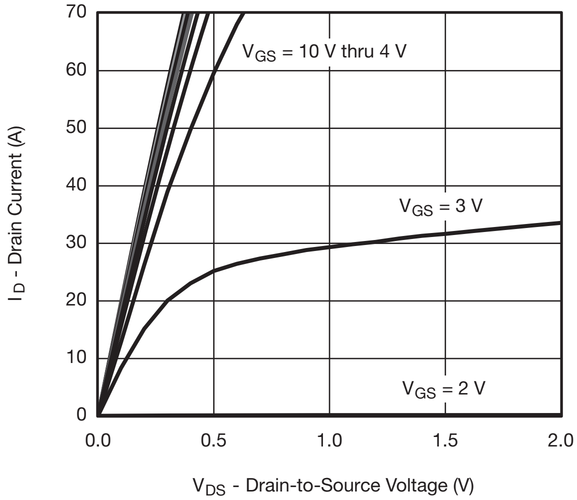
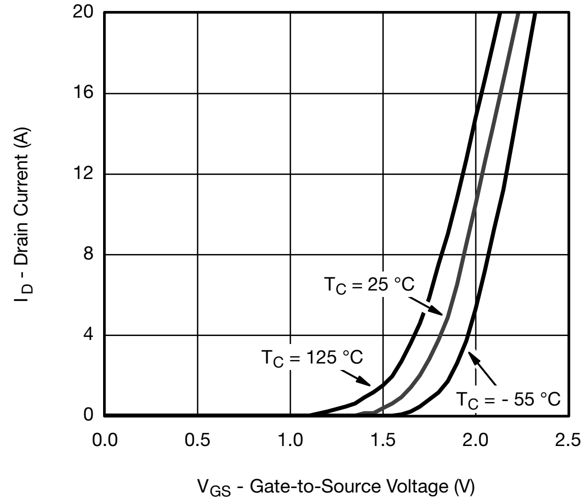
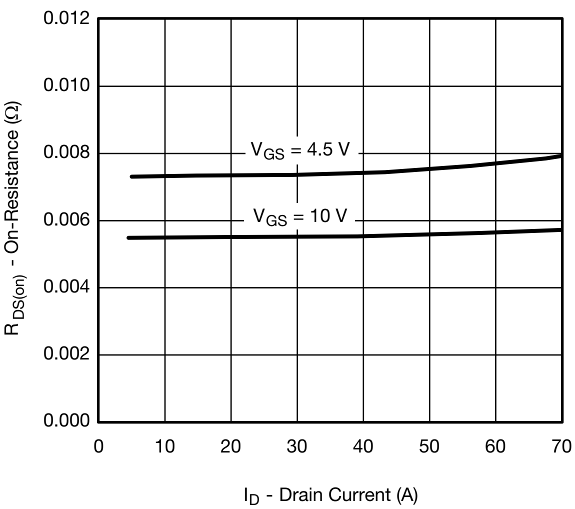
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



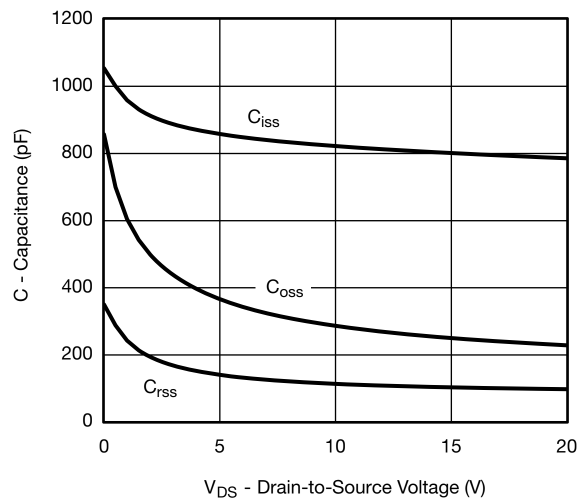
Output Characteristics



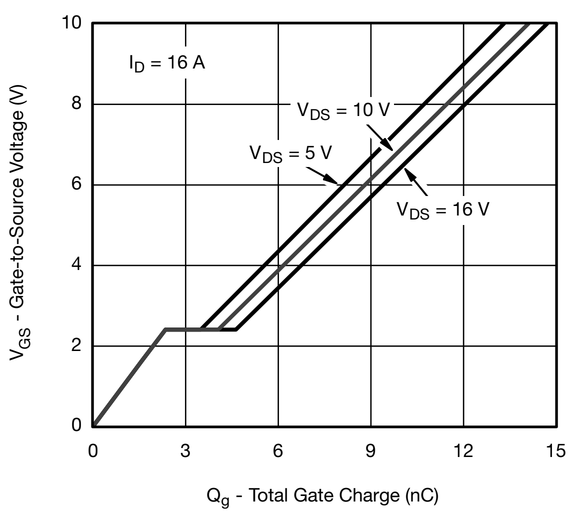
Transfer Characteristics



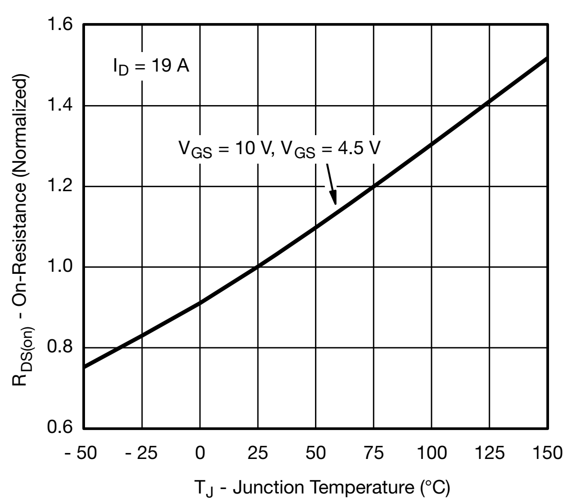
On-Resistance vs. Drain Current



Capacitance



Gate Charge



On-Resistance vs. Junction Temperature

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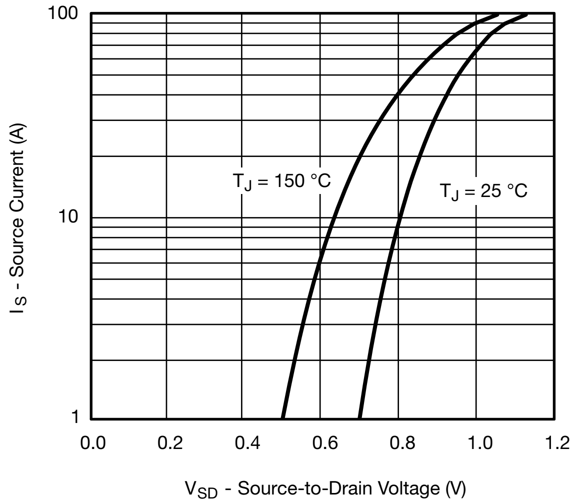
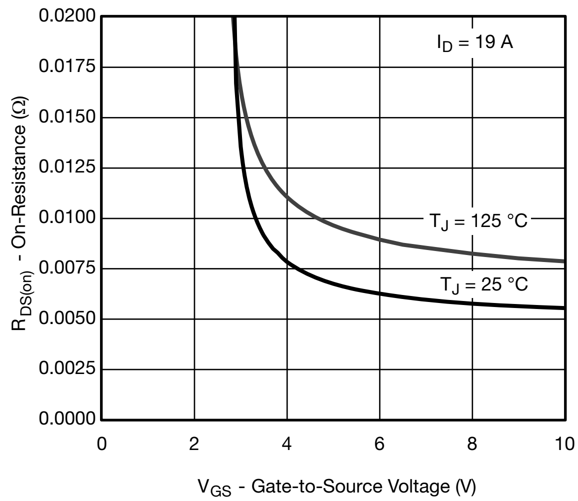
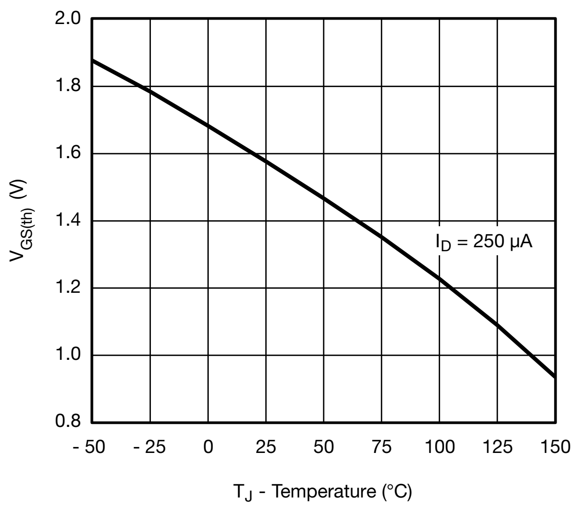


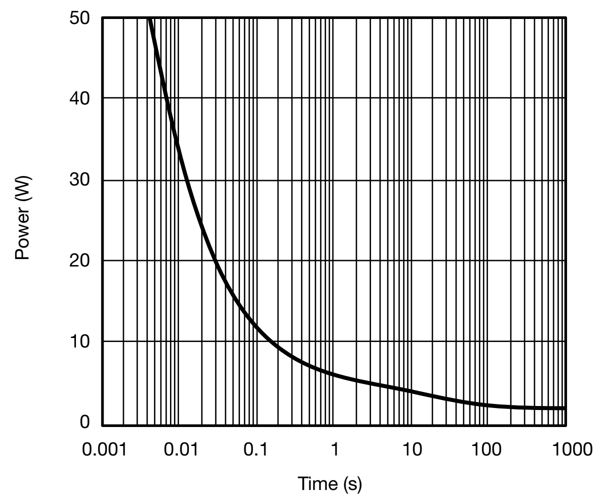
Source-Drain Diode Forward Voltage



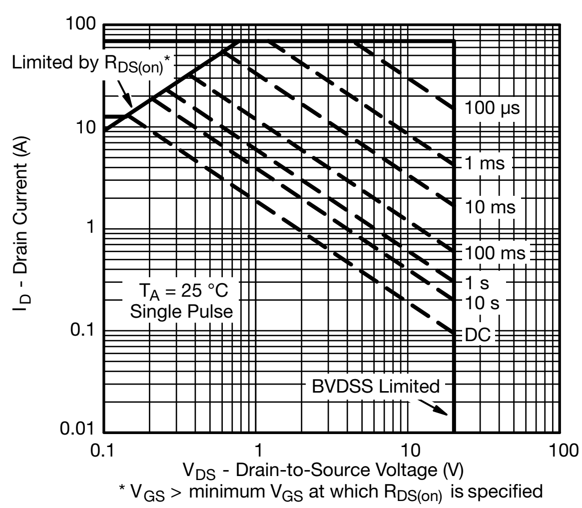
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power



Safe Operating Area, Junction-to-Ambient

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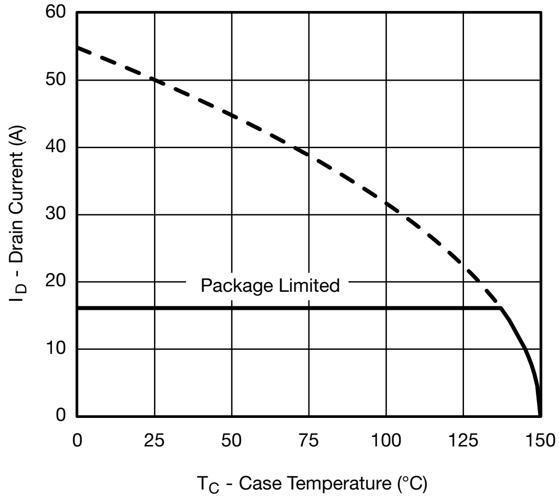
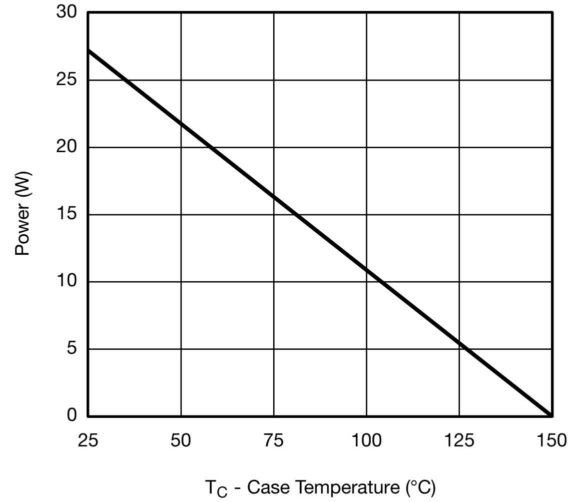
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*



Power, Junction-to-Case

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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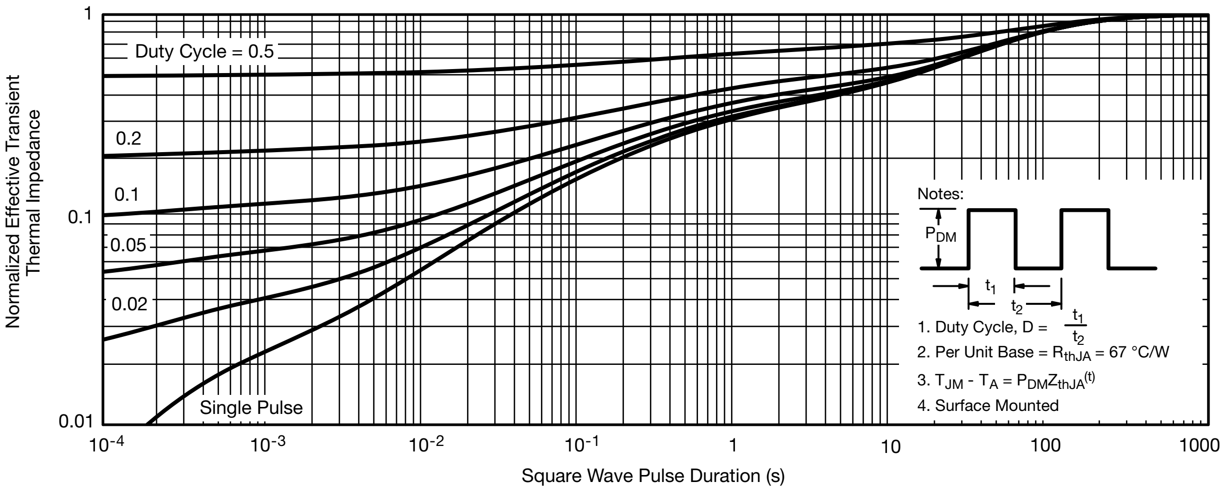
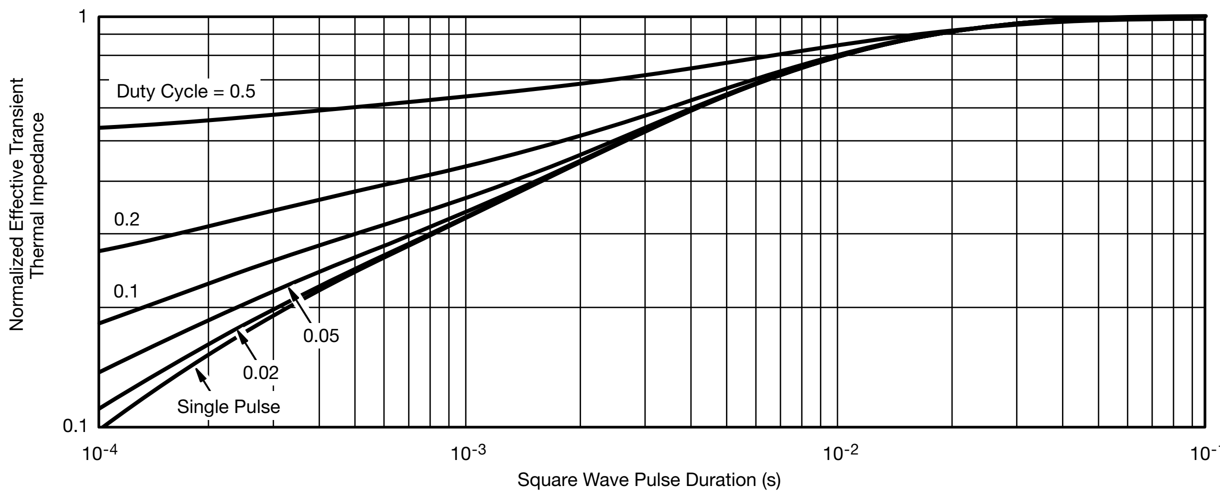


Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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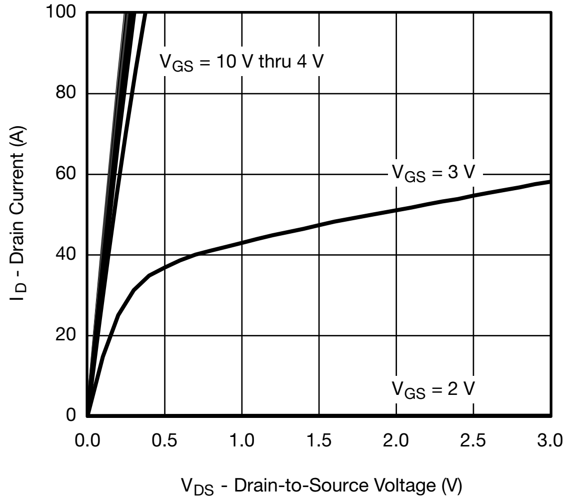
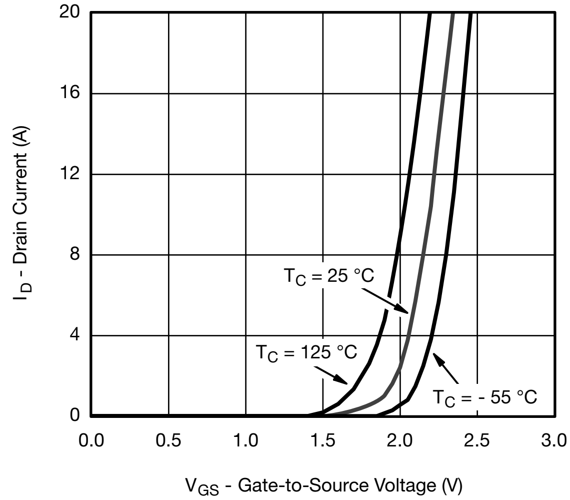
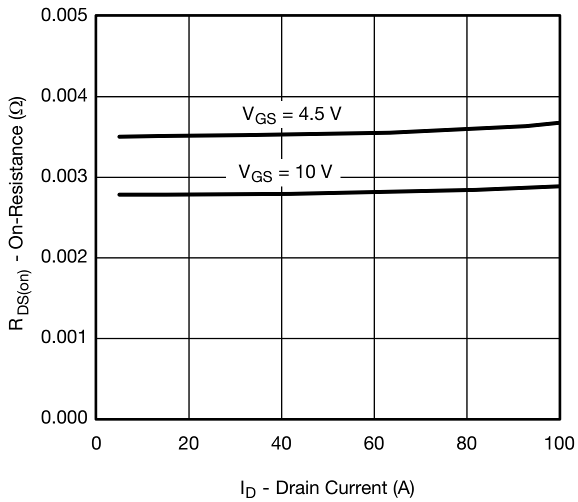
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



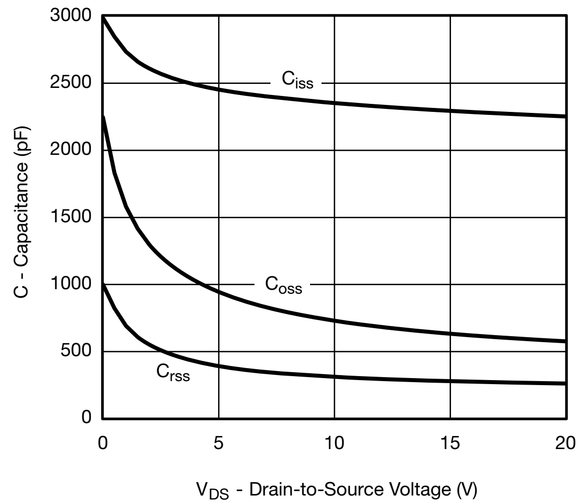
Output Characteristics



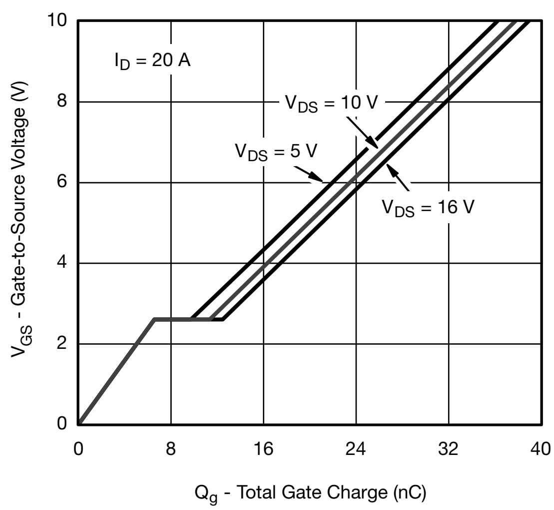
Transfer Characteristics



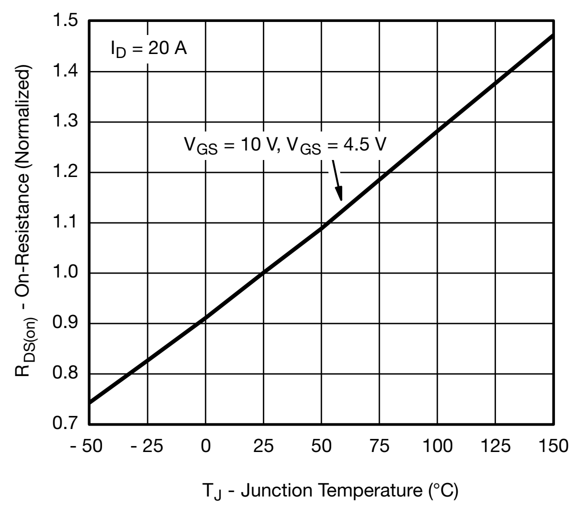
On-Resistance vs. Drain Current



Capacitance



Gate Charge



On-Resistance vs. Junction Temperature

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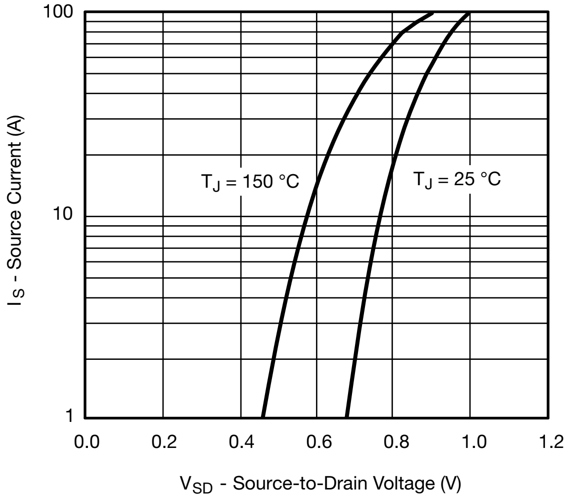
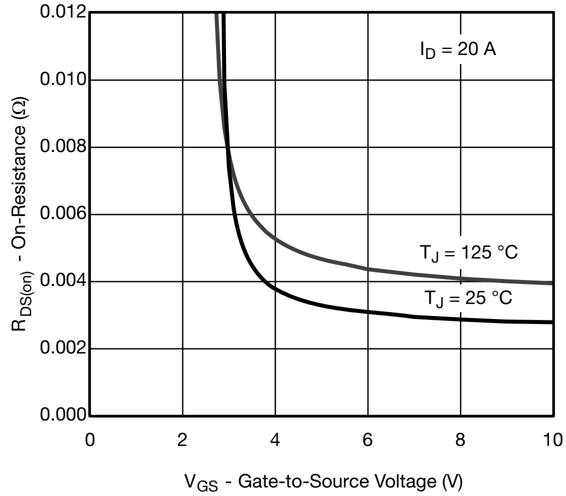
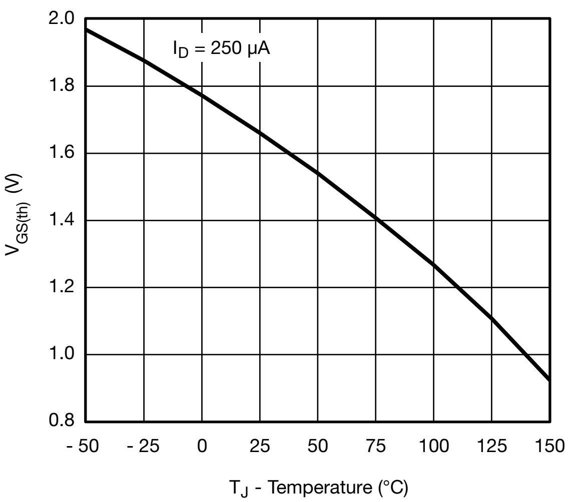
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



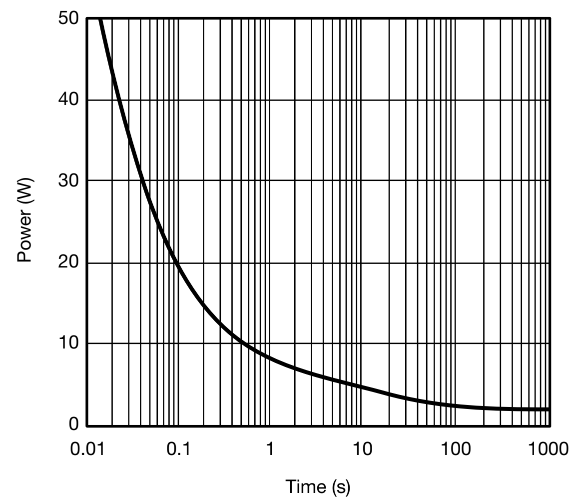
Source-Drain Diode Forward Voltage



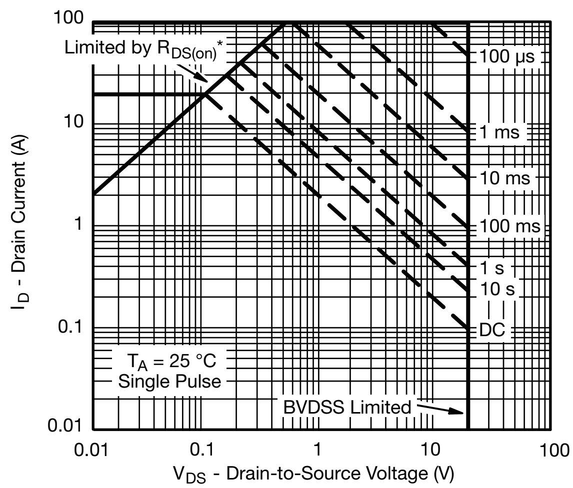
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

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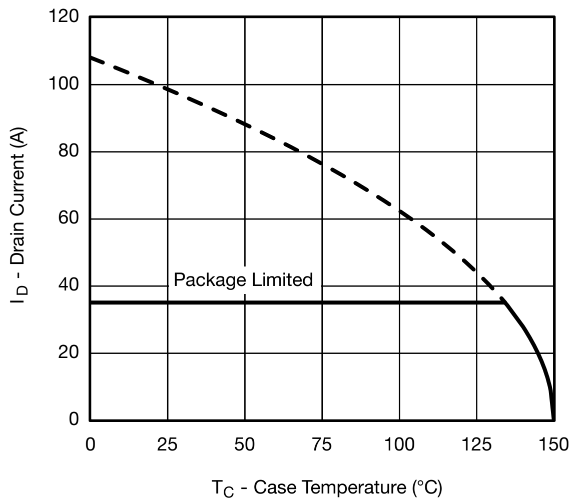
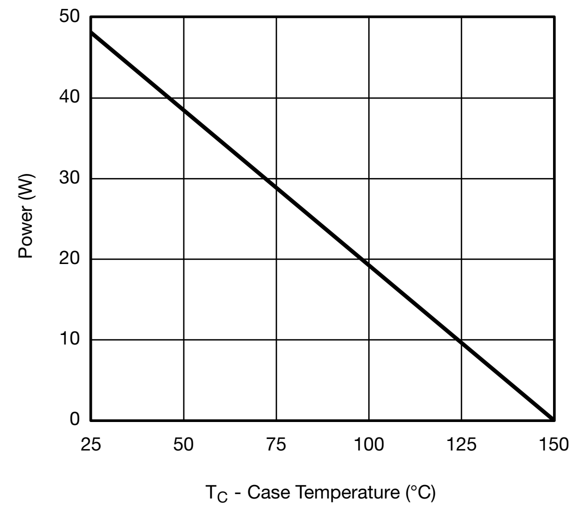
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*



Power, Junction-to-Case

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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S11-2379-Rev. B, 28-Nov-11
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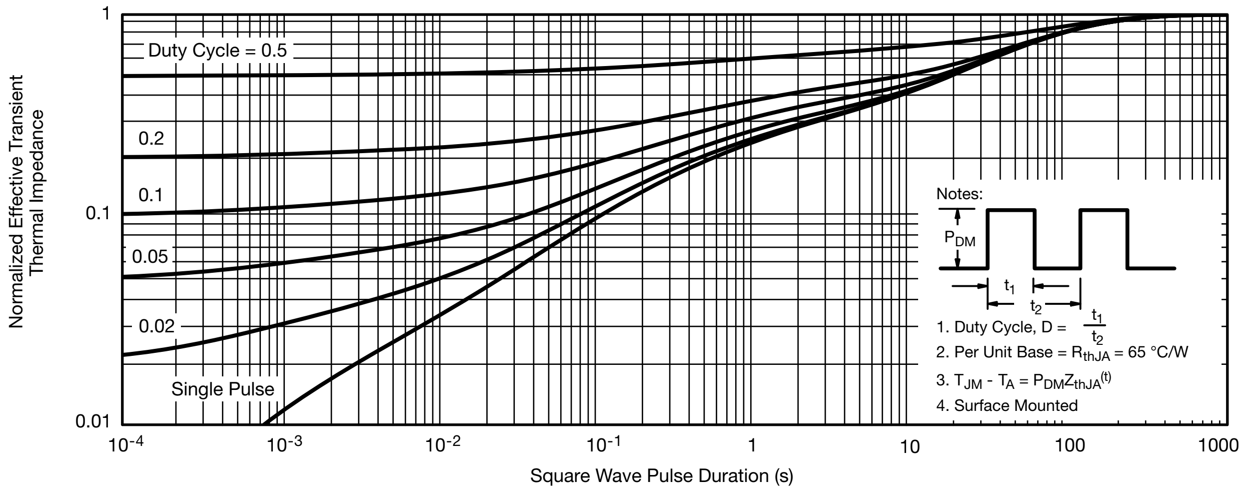
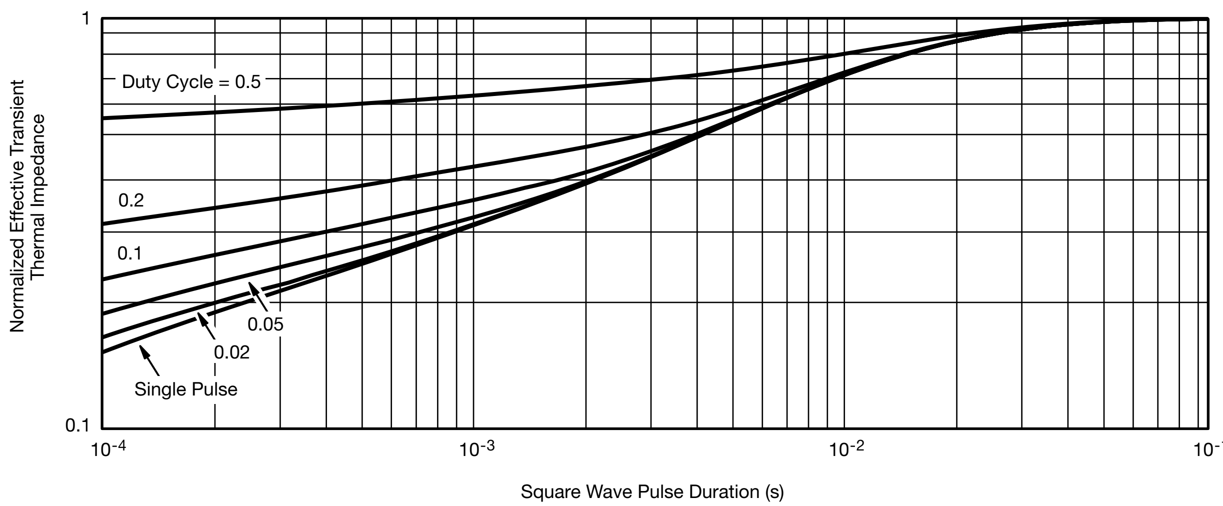
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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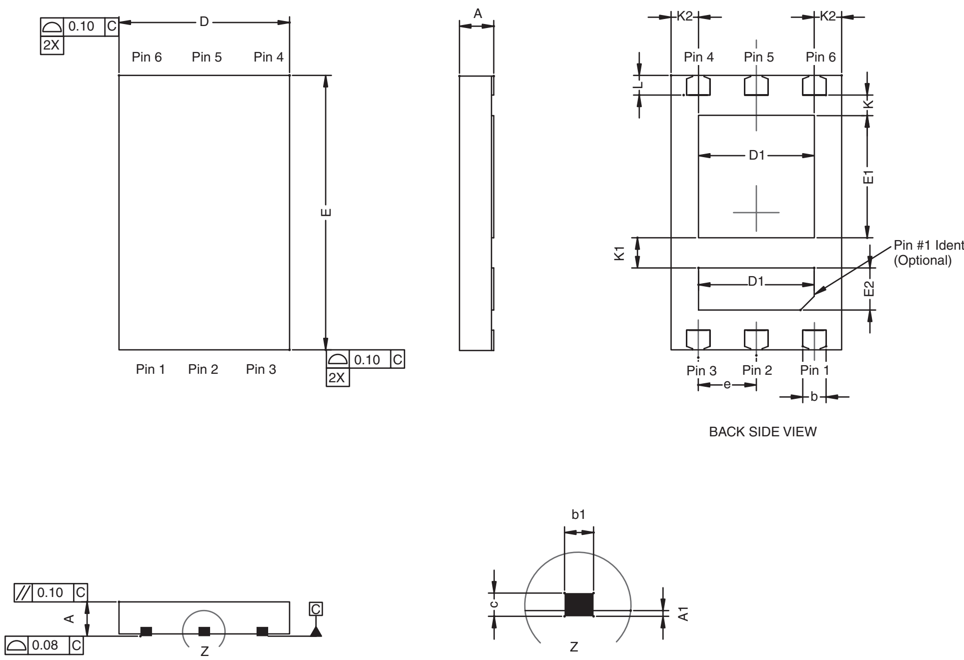
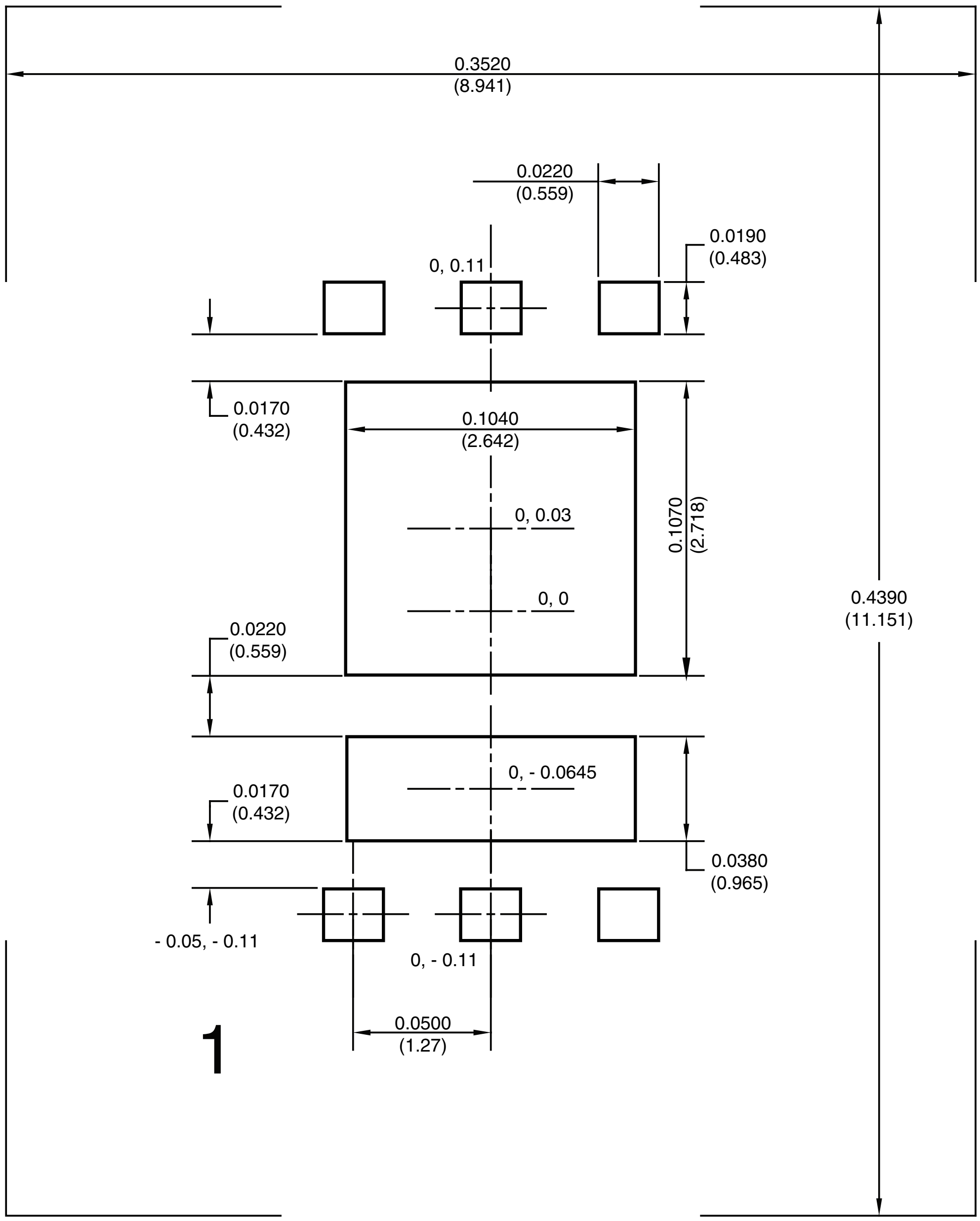
PowerPAIR^{TM} 6 x 3.7 CASE OUTLINE



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.70	0.75	0.80	0.028	0.030	0.032
A1	0.00	-	0.05	0.000	-	0.002
b	0.46	0.51	0.56	0.018	0.020	0.022
b1	0.20	0.25	0.38	0.008	0.010	0.015
C	0.18	0.20	0.23	0.007	0.008	0.009
D	3.65	3.73	3.81	0.144	0.147	0.150
D1	2.41	2.53	2.65	0.095	0.100	0.104
E	5.92	6.00	6.08	0.233	0.236	0.239
E1	2.62	2.67	2.72	0.103	0.105	0.107
E2	0.87	0.92	0.97	0.034	0.036	0.038
e	1.27 BSC			0.05 BSC		
K	0.45 TYP.			0.018 TYP.		
K1	0.66 TYP.			0.026 TYP.		
K2	0.60 TYP.			0.024 TYP.		
L	0.38	0.43	0.48	0.015	0.017	0.019

ECN: S-82772-Rev. B, 17-Nov-08
DWG: 5979

RECOMMENDED PAD FOR PowerPAIR™ 6 x 3.7



Recommended PAD for PowerPAIR 6 x 3.7
Dimensions in inches (mm)
Keep-out 0.3520 (8.94) x 0.4390 (11.151)

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OCEAN CHIPS
Океан Электроники
Поставка электронных компонентов

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- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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«JONHON» (основан в 1970 г.)

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«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).

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